## PATENTS ONLY (ref OG 7/28/92)

To the Honorable Commis Please record the attached -9-02

1. Name of Party(ies) conveying an interest:

> Riyouichi OOTA Tsugihiko HIRANO Atsushi FUJISAWA Takafumi KONNO



10-17-2002

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ks: ereof.

2. Name and Address of Party(ies) receiving an interest:

HITACHI, LTD.

6, Kanda Surugadai 4-chome Chiyoda-ku, Tokyo, JAPAN and

Hitachi Hokkai Semiconductor, Ltd. 145, Azanakajima, Nanaecho, Kameda-gun, Hokkaido, Japan

3. Description of the interest conveyed: Assignment

Application number(s) or patent number(s).

Additional sheet attached? \_ \_\_ Yes XXX No

If this document is being filed together with a new application, the execution date of the application is: \_ DATE

Patent Application No.(s) А

В. Patent No.(s)

09/978,724

Name and address of party to whom correspondence concerning document should be mailed:

> John R. Mattingly Mattingly, Stanger & Malur, P.C. 1800 Diagonal Road, Suite 370 Alexandria, Virginia 22314

- Number of applications and patents involved:
- 7. Amount of fee enclosed or authorized to be charged: \$40.00
- The Commissioner is hereby authorized to charge Deposit Account No. 50-1417 if no check is attached.

DO NOT USE THIS SPACE

Execution date of attached document: October 5, 2001

10. To the best of my knowledge and belief, I declare under penalty of perjury under the laws of the United States of America that the foregoing information is true and correct and that any attached copy is a true copy of the original document.

Daniel J. Stanger

Name of Person Signing

Signature

October 9, 2002

Total number of pages being submitted: 2

10/16/2002 LMUELLER 00000482 09978724

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PATENT REEL: 013376 FRAME: 0089

## ASSIGNMENT

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by HITACHI, LTD. and Hitachi Hokkai Semiconductor, Ltd., corporations organized under the laws of Japan, located at 6, Kanda Surugadai 4-chome, Chiyoda-ku, Tokyo, Japan, and 145, Azanakajima, Nanaecho, Kameda-gun, Hokkaido, Japan, respectively, receipt of which is hereby acknowledged I do hereby sell and assign to said HITACHI, LTD. and Hitachi Hokkai Semiconductor, Ltd., their successors and assigns, all my right, title and interest, in and for the United States of America, in and to

A SEMICONDUCTOR DEVICE AND METHOD OF MANUFACTURING THE SAME

invented by me—(if only one is named below) or us—(if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire owner ship of the said Letters Patent when granted, to be held and enjoyed by said HITACHI, LTD, and Hitachi Hokkai Semiconductor, Ltd., their successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said HITACHI, LTD. and Hitachi Hokkai Semiconductor, Ltd.

Signed on the date(s) indicated aside signatures:

**RECORDED: 10/09/2002** 

	INVENTOR(S) (発明者フルネームサイン)		Date Signed (署名日)
1)	Riyouichi OOTA	(Riyouichi OOTA)	5/October/2001
2)	Tsugihiko HIRANO	(Tsugihiko HIRANO)	5/ October / 2001
3)	Atsushi FWISAWA	(Atsushi FUJISAWA)	5/October/2001
4)	Takafumi Konno	(Takafumi KONNO)	Goctober / 200/
6)			
O)			

PATENT REEL: 013376 FRAME: 0090